Silicon P-Channel MOS FET

HITACHI

Application

Low frequency power amplifier

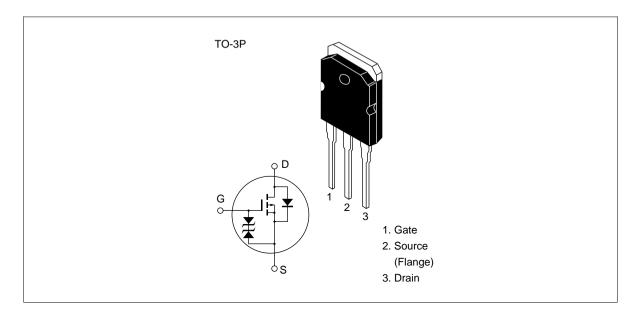
Complementary pair with 2SK1056, 2SK1057 and 2SK1058

Features

- Good frequency characteristic
- High speed switching
- Wide area of safe operation
- Enhancement-mode
- Good complementary characteristics
- Equipped with gate protection diodes
- Suitable for audio power amplifier



Outline



Absolute Maximum Ratings ($Ta = 25^{\circ}C$)

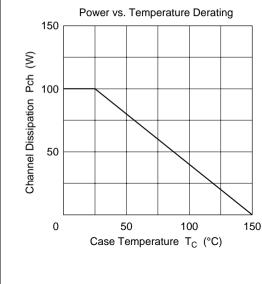
Item		Symbol	Ratings	Unit
Drain to source voltage	2SJ160	V_{DSX}	-120	V
	2SJ161		-140	
	2SJ162		-160	
Gate to source voltage		V_{GSS}	±15	V
Drain current		I _D	- 7	A
Body to drain diode reverse drain current		I _{DR}	- 7	Α
Channel dissipation		Pch*1	100	W
Channel temperature		Tch	150	°C
Storage temperature		Tstg	-55 to +150	°C

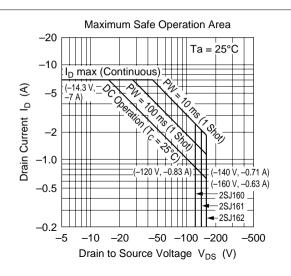
Note: 1. Value at $T_c = 25^{\circ}C$

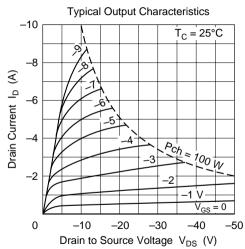
Electrical Characteristics ($Ta = 25^{\circ}C$)

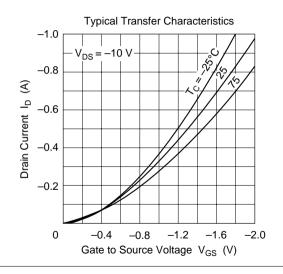
Item		Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source	2SJ160	$V_{(BR)DSX}$	-120	_	_	V	$I_D = -10 \text{ mA}$, $V_{GS} = 10 \text{ V}$
breakdown voltage	2SJ161		-140	_	_	V	
	2SJ162		-160	_	_	V	
Gate to source brea voltage	kdown	$V_{(BR)GSS}$	±15	_	_	V	$I_{\text{G}}=\pm 100~\mu\text{A},~V_{\text{DS}}=0$
Gate to source cuto	ff voltage	$V_{GS(off)}$	-0.15	_	-1.45	V	$I_D = -100 \text{ mA}, V_{DS} = -10 \text{ V}$
Drain to source satu voltage	ıration	$V_{DS(sat)}$	_	_	-12	V	$I_D = -7 \text{ A}, V_{GD} = 0^{*1}$
Forward transfer ad	mittance	y _{fs}	0.7	1.0	1.4	S	$I_D = -3 \text{ A}, V_{DS} = -10 \text{ V}^{*1}$
Input capacitance		Ciss	_	900	_	pF	$V_{GS} = 5 \text{ V}, V_{DS} = -10 \text{V},$
Output capacitance		Coss	_	400	_	pF	f = 1 MHz
Reverse transfer ca	pacitance	Crss	_	40	_	pF	
Turn-on time		t _{on}	_	230	_	ns	$V_{DD} = -20 \text{ V}, I_{D} = -4 \text{ A}$
Turn-off time		t _{off}	_	110	_	ns	

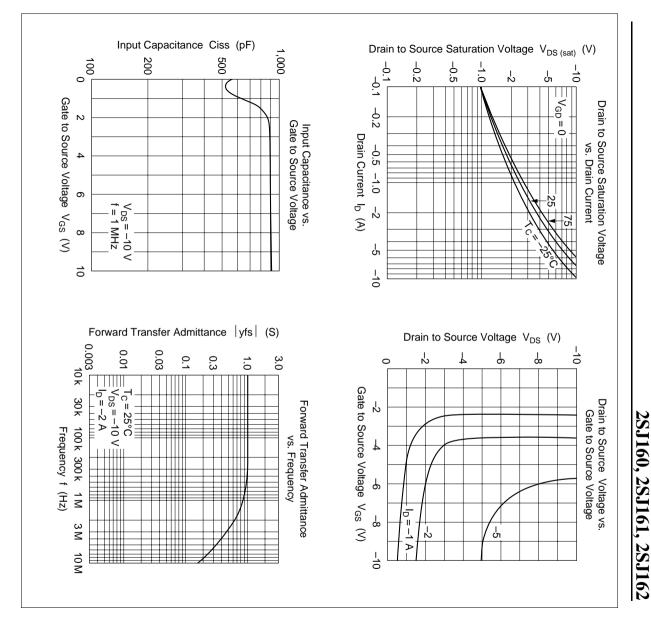
Note: 1. Pulse test

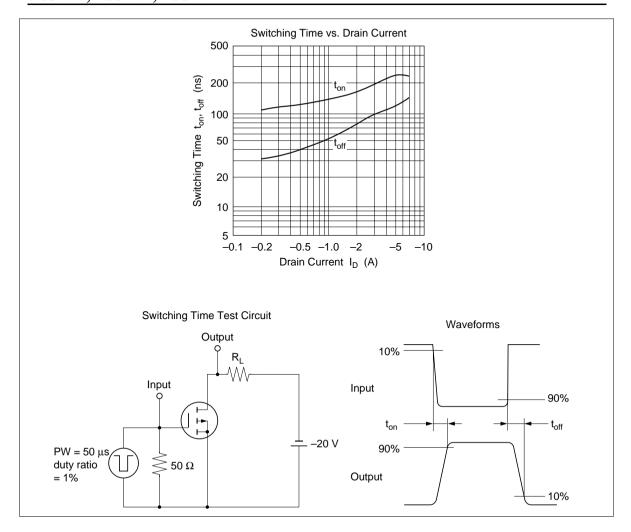




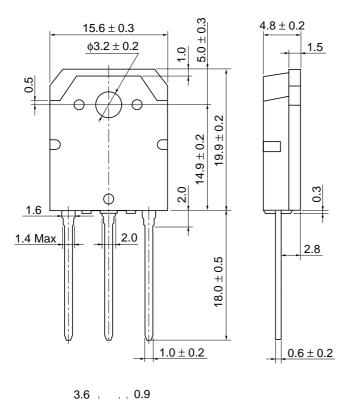


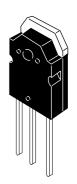






Unit: mm





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5.45 ± 0	0.5					5.4	45 ±	0.5

Hitachi Code	TO-3P
JEDEC	
EIAJ	Conforms
Weight (reference value)	5.0 g

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HITACHI

Hitachi, Ltd.

Semiconductor & Integrated Circuits.

Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan Tel: Tokyo (03) 3270-2111 Fax: (03) 3270-5109

Tel: Tokyo (03) 3270-2111 Fax: (03) 3270-5109

URL NorthAmerica : http:semiconductor.hitachi.com/

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For further information write to:

Hitachi Semiconductor (America) Inc. 179 East Tasman Drive, San Jose,CA 95134 Tel: <1> (408) 433-1990 Fax: <1>(408) 433-0223 Hitachi Europe GmbH Electronic components Group Dornacher Stra§e 3 D-85622 Feldkirchen, Munich Germany Tel: <49> (89) 9 9180-0

Fax: <49> (89) 9 29 30 00

Hitachi Europe Ltd.

Electronic Components Group.

Whitebrook Park Lower Cookham Road Maidenhead

Berkshire SL6 8YA, United Kingdom Tel: <44> (1628) 585000

Tel: <44> (1628) 585000 Fax: <44> (1628) 778322 Hitachi Asia Pte. Ltd. 16 Collyer Quay #20-00 Hitachi Tower Singapore 049318 Tel: 535-2100 Fax: 535-1533

Hitachi Asia Ltd.
Taipei Branch Office
3F, Hung Kuo Building. No.167,
Tun-Hwa North Road, Taipei (105)
Tel: <886> (2) 2718-3666

Fax: <886> (2) 2718-8180

Hitachi Asia (Hong Kong) Ltd.
Group III (Electronic Components)
7/F., North Tower, World Finance Centre,
Harbour City, Canton Road, Tsim Sha Tsui,
Kowloon, Hong Kong
Tel: <852> (2) 735 9218

Fax: <852> (2) 735 9218 Fax: <852> (2) 730 0281 Telex: 40815 HITEC HX

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